

# SID

Factory: Rot am See

Article:

516

ML6

Provided:

Kracht, Enrico

Customer:

Date:

10.08.2015



Processtechnology: B: undefiniert

Material Text	Mat. Nr.	µm	Stackup	Process overview
---------------	----------	----	---------	------------------

A-RS Kupferfolie-018my 330x490mm	50200238	18	VS	1	B00	
A-RS-FR4-Prepreg-7628-TG150-HF	50200643	250		2		
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	0		3		
C-RS-FR4-DS-1.20mm-018+018-TG150-HF	50200899	18	L2	4		A01
		1164				
		18	L3			
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	190		5		
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	0		6		
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	0		7		
C-RS-FR4-DS-1.20mm-018+018-TG150-HF	50200899	18	L4	8		A02
		1164				
		18	L5			
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	250		9		
A-RS-FR4-Prepreg-7628-TG150-HF	50200643	0		10		
A-RS Kupferfolie-018my 330x490mm	50200238	18	RS	11		

Thickness after Pressing

B00:

3090 µm

Tol+:

320 µm

Tol-:

320 µm

Dmax:

3410 µm

Dmin:

2770 µm

Thickness over all

0 µm

Tol+:

0 µm

Tol-:

0 µm

Dmax:

0 µm

Dmin:

0 µm

Demand for customer

Thickness (D):

3200 µm

Tol+:

320 µm

Tol-:

320 µm

Dmax:

3520 µm

Dmin:

2880 µm

Measuring point: (05) über LM und galv.Cu; beidseitig

nominal:

3126 µm

Version 1.2.14.15

© Würth Elektronik